BERGQUIST HI FLOW THF 500
Known as BERGQUIST HI-FLOW 625
November 2018

PRODUCT DESCRIPTION
Reinforced Phase Change Thermal Interface Material.

<table>
<thead>
<tr>
<th>Property</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Technology</td>
<td>Silicone</td>
</tr>
<tr>
<td>Appearance</td>
<td>Green</td>
</tr>
<tr>
<td>Reinforcement Carrier</td>
<td>PEN Film</td>
</tr>
<tr>
<td>Total Thickness , ASTM D374</td>
<td>0.127mm</td>
</tr>
<tr>
<td>Application</td>
<td>Thermal management, Thermally conductive adhesive</td>
</tr>
<tr>
<td>Operating Temperature</td>
<td>150 °C</td>
</tr>
</tbody>
</table>

FEATURES AND BENEFITS
- Thermal impedance: 0.71°C-in²/W @ 25 psi
- Electrically isolating
- 65°C phase change compound coated on PEN film
- Tack-free and scratch-resistant

TYPICAL APPLICATIONS
- Spring/clip mounted
- Power semiconductors
- Power modules

BERGQUIST HI FLOW THF 500 is a film-reinforced phase change material. The product consists of a thermally conductive 65°C phase change compound coated on PEN film. BERGQUIST HI FLOW THF 500 is designed to be used as a thermal interface material between electronic power devices that require electrical isolation and a heat sink.

The reinforcement makes BERGQUIST HI FLOW THF 500 easy to handle, and the 65°C phase change temperature of the coating material eliminates shipping and handling problems. The PEN film has a continuous use temperature of 150°C.

BERGQUIST HI FLOW THF 500 is tack-free and scratch resistant at production temperature and does not require a protective liner in most shipping situations. The material has the thermal performance of 2-3 mil mica and grease assemblies.

TYPICAL PROPERTIES

<table>
<thead>
<tr>
<th>Property</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Elongation, 45° to warp and fill, ASTM D882, %</td>
<td>60</td>
</tr>
<tr>
<td>Tensile Strength, ASTM D882, MPa</td>
<td>206</td>
</tr>
<tr>
<td>Phase Change Temperature, ASTM D3418 °C</td>
<td>65</td>
</tr>
<tr>
<td>Flammability Rating, UL 94</td>
<td>V-0</td>
</tr>
</tbody>
</table>

Electrical Properties
- Dielectric Breakdown Voltage, ASTM D149, Vac | 4,000 V
- Dielectric Constant, ASTM D150 @ 1,000 Hz | 3.5
- Volume Resistivity, ASTM D257, ohm-meter | 1×10¹⁰ Ω

Thermal Properties
- Thermal Conductivity, ASTM D5470, W/(m-K) | 0.5 W/m-K
- Thermal Performance vs. Pressure TO-220
  - @ 10 psi | 2.26 W/°C
  - @ 25 psi | 2.1 W/°C
  - @ 50 psi | 2.0 W/°C
  - @ 100 psi | 1.93 W/°C
  - @ 200 psi | 1.87 W/°C
- Thermal Impedance, ASTM D5470, °C-in²/W | 0.79 W/°C-in²
  - @ 10 psi | 0.79 W/°C-in²
  - @ 25 psi | 0.71 W/°C-in²
  - @ 50 psi | 0.7 W/°C-in²
  - @ 100 psi | 0.67 W/°C-in²
  - @ 200 psi | 0.61 W/°C-in²

1) This is the measured thermal conductivity of the Hi-Flow coating. It represents one conducting layer in a three-layer laminate. The Hi-Flow coatings are phase change compounds. These layers will respond to heat and pressure induced stresses. The overall conductivity of the material in post-phase change, thin film products is highly dependent upon the heat and pressure applied. This characteristic is not accounted for in ASTM D5470. Please contact Bergquist Product Management if additional specifications are required.

2) The ASTM D5470 test fixture was used and the test sample was conditioned at 70°C prior to test. The recorded value includes interfacial thermal resistance. These values are provided for reference only. Actual application performance is directly related to the surface roughness, flatness and pressure applied.

GENERAL INFORMATION
For safe handling information on this product, consult the Safety Data Sheet, (SDS).

Not for product specifications
The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

CONFIGURATIONS AVAILABLE
BERGQUIST HI FLOW THF 500 are supplied in:
- Sheet form, roll form and die-cut parts
- With or without pressure-sensitive adhesive
**Conversions**

\[(°C \times 1.8) + 32 = °F\]

kV/mm x 25.4 = V/mil

mm / 25.4 = inches

N x 0.225 = lb

N/mm x 5.71 = lb/in

psi x 145 = N/mm²

MPa = N/mm²

N·m x 8.851 = lb·in

N·m x 0.738 = lb·ft

N·mm x 0.142 = oz·in

mPa·s = cP

**Disclaimer**

Note:
The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. The product can have a variety of different applications as well as differing application and working conditions in your environment that are beyond our control. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product.

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